Research Article

Zn Electrodeposition on Single-Crystal GaN(0001) Surface: Nucleation and Growth Mechanism

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The electrochemical deposition of zinc on single-crystal n-type GaN(0001) from a sulphate solution has been investigated on the basis of electrochemical techniques including cyclic voltammetry, chronoamperometry, and Tafel plot. The morphology and crystal structure of zinc deposits have been characterized by means of scanning electron microscopy, X-ray diffraction, and energy-dispersive X-ray analysis. The result has revealed that the deposition of Zn on GaN electrode commenced at a potential of $-1.12 \text{V}$ versus Ag/AgCl. According to the Tafel plot, an exchange current density of $\sim 0.132 \text{mAcm}^{-2}$ was calculated. In addition, the current transient measurements have shown that Zn deposition process followed the instantaneous nucleation in 10 mM ZnSO$_4$ + 0.5 M Na$_2$SO$_4$ + 0.5 M H$_3$BO$_3$ (pH = 4).

1. Introduction

The electrodeposition of zinc (Zn) and its alloys are of practical and industrial importance due to their excellent anticorrosive properties [1–5]. Diverse factors, such as pH [6], concentration of Zn ions [7], anions [8], and organic additives [9], are found to influence the Zn electrodeposition. However, it is noted that previous studies of Zn electrodeposition are mostly performed on metal electrodes (e.g., steel [5], nickel [10], platinum [11], copper [12], gold [13], and aluminum [14]). To the best of our knowledge, no report has described the Zn electrodeposition on semiconductor electrodes although they are of interest in modern technologies, such as light-emitting diodes and microelectromechanical systems [15–17]. This is due to complicated thermodynamics and kinetics at metal/semiconductor interface, induced by unique charge transfer, band structure, and weak metal-substrate interaction.

On the other hand, gallium nitride- (GaN-) based materials, with a wide band gap, have recently attracted great attention because of their wide applications in advanced optoelectronic devices [18–20]. Besides physics applications, there is an increasing interest in electrochemistry field due to their unique physicochemical properties. For instance, Pt nanoparticle-modified GaN was found to have potential applications in catalysis and sensors [21, 22]. Pd-S/GaN was a very efficient and recycled green catalyst for Heck reaction [23]. We have demonstrated that GaN might be an elegant alternative catalyst support similar to WO$_3$, TiO$_2$, and ZnO [24–26]. They have shown excellent chemical stability, large potential window for water electrolysis, good electric conductivity, and low background current.

Herein, a study of the electrodeposition of Zn on single-crystal n-type GaN(0001) electrode is presented. The electrochemical reduction of Zn$^{2+}$ from sulphate solution was investigated by basic electrochemical analysis including cyclic voltammetry (CV), chronoamperometry (CA), and Tafel plot. The morphology and crystal structure of Zn deposits were characterized by means of scanning electron microscopy (SEM), X-ray diffraction (XRD), and energy-dispersive X-ray analysis (EDAX).

2. Material and Methods

Single-crystal n-type GaN(0001) substrates were grown on sapphire(0001) by a hydride vapor phase epitaxy. The GaN
layer was 5 \( \mu \text{m} \) thick, Si-doped, and with a carrier concentration of \( 4 \times 10^{18} \text{cm}^{-3} \). Before each experiment, the working electrode of GaN was cleaned with ultrasonication in acetone, ethanol, and distilled water successively for 15 min. The Pt wires (1 mm in diameter) were used as counter electrodes.

Zinc sulphate (ZnSO\(_4\)), boric acid (H\(_3\)BO\(_3\)), sodium sulphate (Na\(_2\)SO\(_4\)), ethanol, and acetone were of analytical grade and purchased from Sinopharm Chemical Reagent Co., Ltd. The electrolyte used in the present study was \( 10 \text{mM ZnSO}_4 + 0.5 \text{M H}_3\text{BO}_3 + 0.5 \text{M Na}_2\text{SO}_4 \) if it was not mentioned. All the solutions were prepared by using Milli-Q water (>18 MΩ) and all the reagents were used as received.

The electrochemical experiments used a standard three-electrode cell arrangement and were undertaken with a CHI 660D potentiostat/galvanostat (Shanghai ChenHua Co., Ltd.). The distance between working and counter electrodes was about 1 cm. The geometric area of GaN in contact with the electrolyte was 0.5 cm\(^2\). All the potentials were reported with respect to a saturated Ag/AgCl electrode (0.197 V versus NHE).

The morphology of Zn deposits was investigated by scanning electron microscopy (Hitachi S4800). The X-ray diffraction (XRD) patterns were recorded on a Bruker D8 Advance Powder X-Ray Diffractometer at a scanning rate of 0.02° s\(^{-1}\) in the 2\( \theta \) range 20 to 80° using Cu-Ka radiation (\( \lambda = 1.5406 \) Å). The energy-dispersive X-ray analysis (EDAX) was performed on a Quanta 400 FEG SEM at 10 KV.

3. Results and Discussion

In principle, electrochemical nucleation involves the diffusion and charge transfer across the electrolyte/electrode interface. In comparison with metal electrodes, the deposition on semiconductor electrodes is more complicated. This is mainly due to the unique band structure of semiconductors, which affects both thermodynamics and kinetics of deposition processes. The existence of Zn(II) in 0.5 M Na\(_2\)SO\(_4\) and 0.5 M H\(_3\)BO\(_3\) solution is generally considered to be Zn\(^{2+}\) due to its stability. The reduction process of Zn\(^{2+}\) can be expressed by

\[
\text{Zn}^{2+} + 2e^- = \text{Zn}. \tag{1}
\]

The Femi level is close to the conduction band due to the high doped concentration. Figure 1 shows the energy band diagram of the \( n \)-type GaN/electrolyte interface. It can be seen that there are two sections. For simplicity, the redox couple is considered as energy states of the Gerischer model of energy levels in the right side. The midpoint between the reduction and oxidation states corresponds to the equilibrium potential, \( E_{\text{O/R}} \), which is equivalent to a Fermi level of a redox system:

\[
E_{\text{O/R}} = E_{\text{O/R}}^\theta + kT \ln \left( \frac{c_{\text{red}}}{c_{\text{ox}}} \right). \tag{2}
\]

The band energy of GaN was cited from the literature [27]. When GaN was in contact with electrolyte, the band energy would bend upward. More importantly, the Fermi energy of semiconductor and solution is equal at the electrostatic equilibrium condition. As a result, a space charge layer (SCL) was formed at the interface between semiconductor and solution, which is equivalent to the built-in potential formed at a Schottky junction [27].

Figure 2 presents typical CVs of GaN electrode in 0.5 M H\(_3\)BO\(_3\)+ 0.5 M Na\(_2\)SO\(_4\) solution with and without 10 mM ZnSO\(_4\) at a scan rate of 10 mV/s. The Open Circuit Potential (OCP) was about 0.18 V. In the first cycle, the cathodic current started to increase when the potential reached \(-1.12 \) V, indicating the beginning of Zn deposition. Moreover, an obvious cathodic reduction peak at potential of \(-1.28 \) V can be observed. As described in the literatures [28, 29], the reduction proceeds in a single step (peak at \(-1.28 \) V) associated with the reduction of Zn(II) ions to Zn(0). No additional peaks are observed before overpotential deposition of Zn, indicating that no underpotential process occurs. This is mainly due to the weak interaction between Zn deposit and GaN. On the reverse scan, the anodic stripping peak is observed at a potential of \(-0.95 \) V due to the dissolution of Zn. In the second cycle, the Zn deposition on GaN electrode commenced more positive than that of first one because some Zn nuclei were still present on the electrode surface.
Figure 3(a) displays the XRD patterns of Zn deposits on GaN. The deposition potential is \(-1.4\) V, and the deposition time is 7200 s. The thickness of the Zn deposits is about 400 nm. The XRD pattern revealed five characteristic peaks at \(2\theta = 38.9^\circ, 43.2^\circ, 54.3^\circ, 70.1^\circ, \) and \(70.6^\circ\), which are attributed to the Zn diffraction peaks of the (100), (101), (102), (103), and (110) planes (JCPDS Card Number 87-0713), respectively. The crystals grew predominantly with a (101) crystallographic orientation. This is consistent with previous references [28]. Figure 3(b) shows the EDAX spectra of Zn deposits on GaN. The EDAX spectra obtained in local points of the electrodeposits surface showed that they were mainly composed by Zn. Gallium and nitrogen were also detected due to the GaN substrate. The detected oxygen may be associated with the oxidation of a little part of Zn(0) in the solution or air.

Figure 4(a) shows a family of CVs of Zn deposited on GaN at different sweep rates. With the decrease of sweep rate, the Zn deposition commences at more positive potential and the peak current increases. Figure 4(b) shows a linear variation of the cathodic peak current density as a function of the square root of the scan rate \((v^{1/2})\). According to Berzins-Delahay equation (3), this linear relation supports the suggestion that the growth of zinc metal is a diffusion-controlled process [30]:

\[
i_p = \frac{0.6106 (nF)^{3/2}}{C_j (RT)^{1/2} D_j^{1/2} v^{1/2}}.
\] (3)
Meanwhile, the electrochemical behavior of Zn on GaN was irreversible. For electron transfer reaction, the cathodic transfer coefficient ($\alpha$) can be calculated by the following equation [31]:

$$\left| V_p - V_{p/2} \right| = 0.048 \alpha$$  \hspace{1cm} (4)

$V_p$ (V) is the peak potential and $V_{p/2}$ (V) is the potential at half peak height. The peak potential depends on the sweep rate, and the number of $\alpha$ is 0.53 at a sweep rate of 10 mV s$^{-1}$. The value of cathodic transfer coefficient is slightly equal to anodic transfer coefficient ($1 - \alpha$).

It is well known that the electrode kinetics can be simply described by the Butler-Volmer equation:

$$j = j_0 \left\{ \exp \left[ (1 - \alpha) \frac{zF}{RT} \eta \right] - \exp \left[ -\alpha \frac{zF}{RT} \eta \right] \right\},$$  \hspace{1cm} (5)

where $j$ (mA cm$^{-2}$) presents the current density, $j_0$ (mA cm$^{-2}$) is the exchange current density, and $\eta$ (V) is the overpotential. For large cathodic overpotentials ($|\eta| > 0.1$ V), the anodic branch is very small and can be neglected. The resulting Tafel law corresponding to electrochemical reaction of Zn$^{2+}$ can then be written as

$$\ln |j| = \ln j_0 - \alpha \frac{zF}{RT} \eta.$$  \hspace{1cm} (6)

Figure 5 illustrates the typical Tafel plot for the electrochemical reduction of Zn$^{2+}$ on GaN electrode. It can be seen that a portion of the curve exhibits a linear relationship in the plot of log $j$ versus potential. This indicates that the mass transport is the dominant rate-limiting step [28]. In addition, the cathodic exchange current density is estimated to be $\sim 0.132$ mA cm$^{-2}$, which is only slightly lower than those on other substrates [7]. This is mainly because the number of free electrons in the conduction band of GaN is lower than metal.

According to the Cottrell equation, diffusion of electroactive species in solution could be quantitatively described from the diffusion coefficient ($D_j$, cm$^2$ s$^{-1}$):

$$|j| = nFAD_j^{1/2}C_j \pi^{-1/2} t^{-1/2}.$$  \hspace{1cm} (7)

$j$ (A) is the cathodic current density, $n$ is the number of electrons exchanged, and $A$ (cm$^2$) is the effective area of the electrode. $D_j$ represents the diffusion coefficient and $C_j$ is the concentration of Zn$^{2+}$. Before the occurrence of the limiting current, by plotting $|j| = f(t^{-1/2})$, a linear graph would be obtained until the growing diffusion layer has reached its maximum width.

Figure 6(a) shows potentiostatic current transients of Zn deposition on GaN; the inset shows an enlargement of the transient curve for the first seconds; (b) Cottrell plot for the determination of the diffusion coefficient of Zn$^{2+}$ species.
reverse pulse is maintained constant at −0.15 V, and the pulse
time is 50 s. The resulting curves of the transients are a
typical response of an electrochemical nucleation and growth
process. The inset shows an enlargement of the transient
curve for the first seconds. It is clear that the nucleation
stage lasts about 0.3 s. The rapid increase in current at very
short times indicates the growth of the new phase and the
increasing number of nuclei present on the electrode surface.
As these grow, the coalescence of neighboring diffusion
fields with localized spherical symmetry gives rise to a
current maximum, followed by a decaying current, related to
planar electrode diffusion. It decreases asymptotically until
reaching a constant current value. Furthermore, the charges
associated with the reduction and oxidation processes, \( Q_C \)
and \( Q_A \), were obtained by integrating the cathodic and
the anodic branches of the current transients. The values
of \( Q_C \) and \( Q_A \) were 41.95 mA and 29.83 mA, respectively.
That is, the efficiency \( (Q_A/Q_C) \) of Zn ions reduction on
the GaN electrode was 0.689. This further confirmed that
the electrochemical behavior of Zn on GaN was irreversible
although the contribution of hydrogen reduction to the
\( Q_C \) cannot be excluded completely. The linear part of the
experimental Cottrell plot can be seen in Figure 6(b) as
well as the corresponding data fit. The diffusion coefficient
of \( D_j \) was evaluated by analyzing the experimental data that
corresponds to the fall of the direct pulse transients. The
diffusion coefficient of \( D_j = 3.33 \times 10^{-5} \) cm\(^2\) s\(^{-1}\) was found
for Zn\(^{2+} \) species. This value is comparable to the literatures
[4, 28, 29].

The electrocrystallization process of Zn is limited by
diffusion, thus the transients in Figure 5 can be analyzed through a 3D growth for an instantaneous nucleation:

\[
\frac{zFD_j^{1/2}}{\pi^{1/2}t^{1/2}} \left[ 1 - \exp \left( -N_s \pi tK_D j \right) \right],
\]

or for a progressive type nucleation:

\[
\frac{zFD_j^{1/2}C_j}{\pi^{1/2}t^{1/2}} \left[ 1 - \exp \left( -2AN_s \pi t^2 K_D j \right) \right].
\]

\( N_s \) (cm\(^{-2} \)) is number density of nucleation active sites, \( A \) (s\(^{-1} \)) is the steady-state nucleation rate active site, and \( K \) is the
nondimensional growth rate constant of a nucleus, defined as
\( K = (8\pi C_j M/\rho)^{1/2} \). Table 1 shows the values of nucleation kinetic parameter \( N_s \) for different concentration and potential.

The experimental values of \( j_m \) and \( t_m \) could be obtained from the potentiostatic transients, and theoretical maximum values can be evaluated by the following equations, for the instantaneous case:

\[
\frac{1.2564}{t_m \pi KD_j},
\]

\[
\frac{2.3367(\frac{t}{t_m})}{1 - \exp \left( -2.3367(\frac{t}{t_m}) \right)^2}.
\]

For the progressive case:

\[
\frac{1.9542}{t/t_m} \left( 1 - \exp \left( -1.2564(\frac{t}{t_m}) \right) \right)^2.
\]

\[
\frac{1.2254}{t/t_m} \left( 1 - \exp \left( -2.3367(\frac{t}{t_m}) \right)^2 \right).
\]

Figure 7(a) illustrates current transients for Zn deposition
onto GaN electrode within potential range from 1.25 V to
1.4 V. Regardless of the electrode potential all the curves
have similar shape and are characterized by sharp increase
of cathodic current at the initial stages of deposition followed
by a drop at longer times. These features of current transients
are relevant to 3D Zn nucleation followed by diffusion
limited growth. Figure 7(b) shows the normalized cathodic
transients from Figure 7(a) together with the theoretical
curves for instantaneous and progressive 3D nucleation and
growth based on (12) and (13). Figure 7(c) shows a series of
deposition transients for deposition of zinc from the different
discrimination potential of ZnSO\(_4\) and same potential (−1.4 V). The
black lines of Figures 7(b) and 7(d) are the theoretical
curves for instantaneous and progressive nucleation. From
the results in Figure 7(b), in which the solution concentration
of ZnSO\(_4\) is 10 mM, the first half of the nucleation plot has
good correlation with the theoretical curve for instantaneous
nucleation, while the second half of the nucleation plots
transition from progressive to instantaneous nucleation with
the potentials increasing from −1.25 V (green lines) to −1.4 V
(red lines). Meanwhile, we can know that the mechanism of
Zn is different at various concentration from Figure 7(d)
and the red, green, and blue lines are the 5 mM, 10 mM, and
20 mM. The nucleation plots transition is gradually close

<table>
<thead>
<tr>
<th>Potential/V</th>
<th>( C_j ) (Zn(^{2+} ))/mol cm(^{-3} )</th>
<th>( N_s ) (instantaneous)</th>
<th>( N_s ) (progressive)</th>
</tr>
</thead>
<tbody>
<tr>
<td>−1.25</td>
<td>( 1 \times 10^{-5} )</td>
<td>0.78 \times 10^{-5}</td>
<td>1.26 \times 10^{-5}</td>
</tr>
<tr>
<td>−1.3</td>
<td>( 1 \times 10^{-5} )</td>
<td>1.78 \times 10^{-5}</td>
<td>1.89 \times 10^{-5}</td>
</tr>
<tr>
<td>−1.4</td>
<td>( 1 \times 10^{-5} )</td>
<td>2.91 \times 10^{-5}</td>
<td>4.71 \times 10^{-5}</td>
</tr>
<tr>
<td>−1.4</td>
<td>( 5 \times 10^{-6} )</td>
<td>1.97 \times 10^{-5}</td>
<td>3.18 \times 10^{-5}</td>
</tr>
<tr>
<td>−1.4</td>
<td>( 2 \times 10^{-5} )</td>
<td>2.25 \times 10^{-5}</td>
<td>3.64 \times 10^{-5}</td>
</tr>
</tbody>
</table>
to instantaneous nucleation with increasing Zn\(^{2+}\) concentration.

Figures 8(a)–8(d) show a family of SEM images of Zn deposits on GaN. The applied potential was \(-1.4\) V and the deposition time was varied from 10, 20, 40, to 80 s. It can be seen that Zn nuclei were formed on GaN electrode and followed by a 3D island growth (Volmer-Weber) mechanism because of the weak interaction between GaN and Zn. The nuclei density increased and coalescence occurred when the deposition time was varied from 10 to 80 s.

4. Conclusion

The electrodeposition of Zn on \(n\)-type single-crystal GaN(0001) from a sulphate solution has been studied by electrochemical techniques and SEM. Zn deposition on GaN electrode commenced at a potential of \(-1.12\) V without underpotential deposition and was irreversible and mass-transfer limited. The deposition occurred on the conduction band of GaN due to the negative equilibrium potential. Moreover, the exchange current density of \(~0.132\ \text{mA cm}^{-2}\) was calculated on the basis of Tafel plot. The current transient measurements indicated that the deposition process accorded with the progressive nucleation.

Conflict of Interests

The authors declare that there is no conflict of interests regarding the publication of this paper.

Acknowledgments

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Figure 8: SEM images of Zn deposits on GaN electrode with an applied potential of $-1.4 \text{ V}$. The deposition time was (a) 10, (b) 20, (c) 40, and (d) 80 s.

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